

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Packaging	Typical Dimension mm(inches)
1	IC1	1	—	TCR15AG (fixed output voltage type)	TOSHIBA		WCSP6F	1.2 x 0.8
2	C1 (C _{BIAS})	1	1.0μF			Ceramic, 10V, ±10%	—	1.0 x 0.5 (0402)
3	C2 (C _{IN})	1	4.7μF			Ceramic, 10V, ±10%	—	1.6 x 0.8 (0603)
4	C3 (C _{OUT})	1	4.7μF			Ceramic, 10V, ±10%	—	1.6 x 0.8 (0603)

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